

XR76203-Q/XR76205-Q/XR76208-Q

AEC-Q100 Qualified 40V PowerBloxTM 3A/5A/8A Synchronous Step Down COT Regulator

General Description

The XR76203-Q, XR76205-Q and XR76208-Q are synchronous stepdown regulators combining the controller, drivers, bootstrap diode and MOSFETs in a single package for point-of-load supplies well suited for automotive applications. Qualified per AEC-Q100, the XR76203-Q, XR76205-Q and XR76208-Q have load current ratings of 3A, 5A and 8A respectively. A wide 5.5V to 40V input voltage range allows for single supply operation from 12V battery systems required to withstand load dump, industry standard 24V ±10%, 18V-36V, and rectified 18VAC and 24VAC rails.

With a proprietary emulated current mode Constant On-Time (COT) control scheme, the XR76203-Q, XR76205-Q and XR76208-Q provide extremely fast line and load transient response using ceramic output capacitors. They require no loop compensation, simplifying circuit implementation and reducing overall component count. The control loop also provides 0.07% load and 0.15% line regulation and maintains constant operating frequency. A selectable power saving mode allows the user to operate in discontinuous conduction mode (DCM) at light current loads thereby significantly increasing the converter efficiency.

A host of protection features, including over-current, over-temperature, short-circuit and UVLO, helps achieve safe operation under abnormal operating conditions.

The XR76203/5/8-Q are available in a RoHS-compliant, green/halogen-free space-saving QFN 5x5mm package.

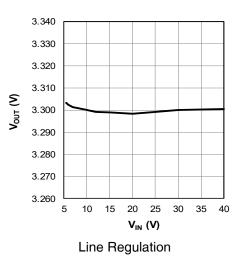
FEATURES

- Automotive AEC-Q100 Qualified
 Temperature Grade 1: -40°C to 125°C
- HBM ESD Class Level 2
- CDM ESD Class Level C4B
- Controller, drivers, bootstrap diode and MOS-FETs integrated in one package
- 3A, 5A and 8A Step Down Regulators
 □ Wide 5.5V to 40V Input Voltage Range
 □ ≥0.6V Adjustable Output Voltage
- Proprietary Constant On-Time Control
 No Loop Compensation Required
 - □ Stable Ceramic Output Capacitor Operation
 - Programmable 200ns to 2µs On-Time
 - Constant 100kHz to 800kHz Frequency
- Selectable CCM or CCM/DCM
- CCM/DCM for high efficiency at light-load
 CCM for constant frequency at light-load
- Programmable Hiccup Current Limit with Thermal Compensation
- Precision Enable and Power Good flag
- Programmable Soft-start
- 30-pin 5x5mm QFN package with wettable flanks

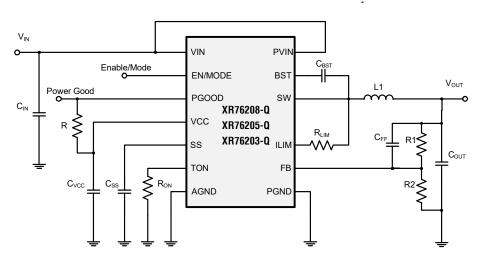
APPLICATIONS

- Automotive Systems
- Distributed Power Architecture
- Point-of-Load Converters
- Power Supply Modules
- FPGA, DSP, and Processor Supplies
- Industrial and Military

Ordering Information - Back Page



Typical Application



Absolute Maximum Ratings

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

PV_{IN},V_{IN} 0.3V to 43V
V _{CC} 0.3V to 6.0V
BST0.3V to 48V ¹
BST-SW0.3V to 6V
SW, ILIM1V to 43V ^{1, 2}
ALL other pins0.3V to VCC+0.3V
Storage Temperature65°C to +150°C
Junction Temperature
Power DissipationInternally Limited
Lead Temperature (Soldering, 10 sec)
ESD Rating (HBM - Human Body Model)±2kV
ESD Rating (Charged device model (CDM) per AEC Q100-011, Non-corner pins±500V
ESD Rating (Charged device model (CDM) per AEC Q100-011, Corner pins 1, 7, 8, 14, 15, 22, 23, 30±750V

Operating Conditions

PV _{IN}
V _{IN}
SW, ILIM1V to 40V ¹
PGOOD, $V_{CC},T_{ON},SS,EN,FB0.3V$ to 5.5V
Switching Frequency100kHz to 800kHz ³
Junction Temperature Range40°C to +125°C
XR76203-Q Package Thermal Resistance, $\theta_{JA}28^\circ\text{C/W}$
XR76205-Q Package Thermal Resistance, $\theta_{JA}26^\circ\text{C/W}$
XR76208-Q Package Thermal Resistance, $\theta_{JA}25^\circ\text{C/W}$
XR76203-Q Package Power Dissipation at 25°C3.6W
XR76205-Q Package Power Dissipation at 25°C
XR76208-Q Package Power Dissipation at 25°C4.0W

Note 1: No external voltage applied.

Note 2: SW pin's minimum DC range is -1V, transient is -5V for less than 50ns. Note 3: Recommended frequency

Electrical Characteristics

Unless otherwise noted: T_J= 25°C, V_{IN}=24V, BST=V_{CC}, SW=AGND=PGND=0V, C_{VCC}=4.7uF. Limits applying over the full operating temperature range are denoted by a "•"

Symbol	Parameter	Conditions		Min	Тур	Max	Units
Power Sup	ply Characteristics						
V _{IN}	Input Voltage Range	VCC regulating	•	5.5		40	V
I _{VIN}	VIN Input Supply Current	Not switching, $V_{IN} = 24V$, $V_{FB} = 0.7V$	٠		0.7	2	mA
I _{VIN}	VIN Input Supply Current (XR76203-Q)	f=300kHz, R _{ON} =215k, VFB=0.58V			12		mA
I _{VIN}	VIN Input Supply Current (XR76205-Q)	f=300kHz, R _{ON} =215k, VFB=0.58V			15		mA
I _{VIN}	VIN Input Supply Current (XR76208-Q)	f=300kHz, R _{ON} =215k, VFB=0.58V			19		mA
I _{OFF}	Shutdown Current	Enable = 0V, V_{IN} = 12V			1		μA
Enable and	Enable and Under-Voltage Lock-Out UVLO						
$V_{\rm IH_EN_1}$	EN Pin Rising Threshold		•	1.8	1.9	2.0	V
$V_{\text{EN}_{\text{H}_{1}}}$	EN Pin Hysteresis				70		mV
$V_{\text{IH}_\text{EN}_2}$	EN Pin Rising Threshold for DCM/CCM operation		•	2.8	3.0	3.1	V
V _{EN_H_2}	EN Pin Hysteresis				100		mV

XR76203-Q/XR76205-Q/XR76208-Q

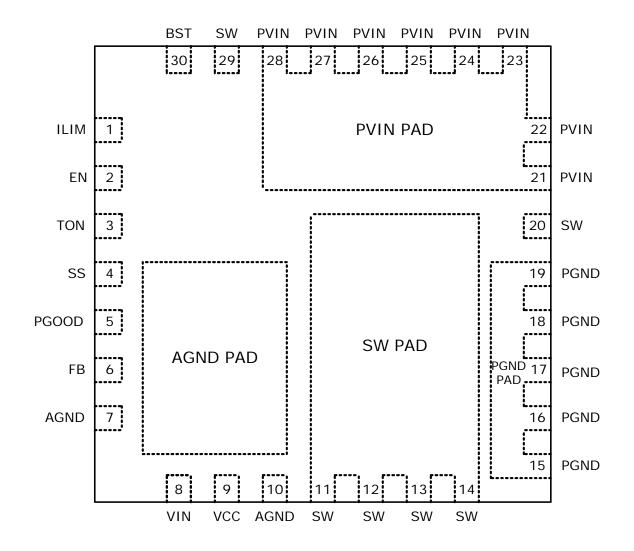
Symbol	Parameter	Conditions		Min	Тур	Max	Units
	VCC UVLO Start Threshold, Rising Edge		•	4.00	4.25	4.40	V
	VCC UVLO Hysteresis				230		mV
Reference	Voltage			•	1	1	
		V _{IN} = 5.5V to 40V, VCC regulating		0.596	0.600	0.604	V
V _{REF}	Reference Voltage	V _{IN} = 5.5V to 40V, VCC regulating	•	0.594	0.600	0.606	V
	DC Line Regulation	CCM, closed loop, V _{IN} =5.5V-40V, applies to any C_{OUT}			±0.33		%
	DC Load Regulation	CCM, closed loop, applies to any C _{OUT}			±0.39		%
Programm	able Constant On-Time			•	1	1	
T _{ON1}	On-Time 1	R _{ON} = 237k, V _{IN} = 40V	•	1570	1840	2120	ns
	f Corresponding to On-Time 1	V _{OUT} = 24V, V _{IN} = 40V, R _{ON} = 237k	•	283	326	382	kHz
T _{ON(MIN)}	Minimum Programmable On-Time	R _{ON} = 14k, V _{IN} = 40V			120		ns
T _{ON2}	On-Time 2	R _{ON} = 14k, V _{IN} = 24V	•	174	205	236	ns
T _{ON3}	On-Time 3	R _{ON} = 35.7k, V _{IN} = 24V	•	407	479	550	ns
	f Corresponding to On-Time 3	V _{OUT} = 3.3V, V _{IN} = 24V, R _{ON} = 35.7k	•	250	287	338	kHz
	f Corresponding to On-Time 3	V _{OUT} = 5.0V, V _{IN} = 24V, R _{ON} = 35.7k	•	379	435	512	kHz
	Minimum Off-Time		•		250	350	ns
Diode Emu	lation Mode			•	1	1	
	Zero Crossing Threshold	DC value measured during test			-2		mV
Soft-start		·		•			
	SS Charge Current		•	-14	-10	-6	μA
	SS Discharge Current	Fault present	•	1			mA
VCC Linea	r Regulator						
	VCC Output Voltage	$V_{IN} = 6V$ to 40V, $I_{LOAD} = 0$ to 30mA	•	4.8	5.0	5.2	V
	VCC Output Voltage	$V_{IN} = 5V$, $I_{LOAD} = 0$ to 20mA	•	4.51	4.7		V
Power Goo	od Output						
	Power Good Threshold			-10	-6.9	-5	%
	Power Good Hysteresis				1.6	4	%
	Power Good Sink Current			1			mA
Protection	OCP, OTP, Short-Circuit						
	Hiccup Timeout				110		ms
	ILIM Pin Source Current			45	50	55	μΑ
	ILIM Current Temperature Coefficient				0.4		%/°C
	OCP Comparator Offset		•	-8	0	+8	mV
	Current Limit Blanking	GL rising>1V			100		ns

XR76203-Q/XR76205-Q/XR76208-Q

Symbol	Parameter	Conditions		Min	Тур	Мах	Units
	Thermal Shutdown Threshold ¹	Rising temperature			150		°C
	Thermal Hysteresis ¹				15		°C
	VSCTH Feedback Pin Short-Circuit Threshold	Percent of V _{REF} short circuit is active after PGOOD is asserted	٠	50	60	70	%
XRP76203	Output Power Stage						
P	High-Side MOSFET R _{DSON}	1			115	160	mΩ
R _{DSON}	Low-Side MOSFET R _{DSON}	- I _{DS} = 1A			40	59	mΩ
I _{OUT}	Maximum Output Current		•	ЗA			A
XRP76205	Output Power Stage						
Р	High-Side MOSFET R _{DSON}				42	59	mΩ
R _{DSON}	Low-Side MOSFET R _{DSON}	$I_{DS} = 2A$			40	59	mΩ
I _{OUT}	Maximum Output Current		•	5A			А
XRP76208	Output Power Stage						
R _{DSON}	High-Side MOSFET R _{DSON}	- I _{DS} = 2A			42	59	mΩ
	Low-Side MOSFET R _{DSON}				16.2	21.5	mΩ
I _{OUT}	Maximum Output Current		•	8A			А

Note 1: Guaranteed by design

Pin Configuration, Top View

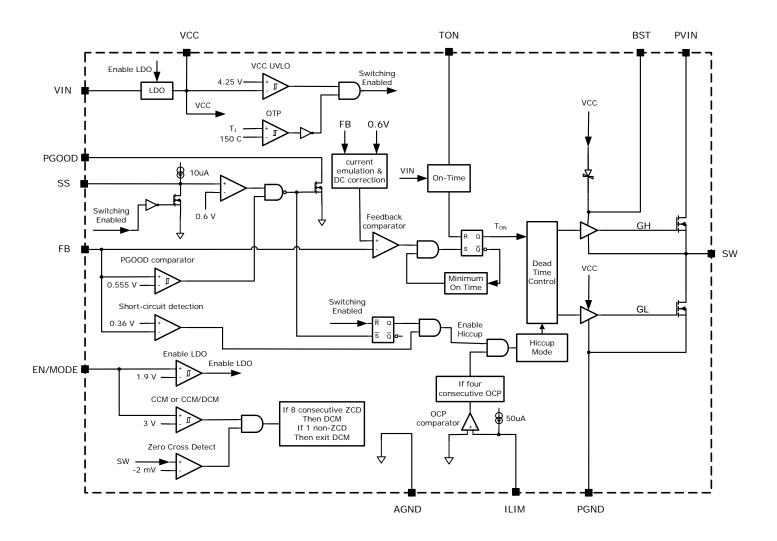


Pin Assignments

Pin No.	Pin Name	Туре	Description			
1	ILIM	А	Over-current protection programming. Connect with a resistor to SW.			
2	EN/MODE	I	Precision enable pin. Pulling this pin above 1.9V will turn the regulator on and it will operate in CCM. If the voltage is raised above 3.0V then the regulator will operate in DCM/CCM depending on load			
3	TON	А	Constant on-time programming pin. Connect with a resistor to AGND.			
4	SS	A	Soft-Start pin. Connect an external capacitor between SS and AGND to program the soft-st rate based on the 10uA internal source current.			
5	PGOOD	O, OD	Power-good output. This open-drain output is pulled low when V_{OUT} is outside the regulation.			
6	FB	A	Feedback input to feedback comparator. Connect with a set of resistors to VOUT and AGN in order to program V_{OUT} .			
7, 10, AGND Pad	AGND	A	Signal ground for control circuitry. Connect AGND Pad with a short trace to pins 7 and 10.			
8	VIN	А	Supply input for the regulator's LDO. Normally it is connected to PVIN.			
9	VCC	А	The output of regulator's LDO. For operation using a 5V rail, VCC should be shorted to VIN.			
11-14, 20, 29, SW Pad	SW	PWR	Switch node. Drain of the low-side N-channel MOSFET. Source of the high-side MOSFET is wire-bonded to the SW Pad. Pins 20 and 29 are internally connected to SW pad.			
15-19, PGND Pad	PGND	PWR	Ground of the power stage. Should be connected to the system's power ground plane. Sour of the low-side MOSFET is wire-bonded to PGND Pad.			
21-28, PVIN Pad	PVIN	PWR	Input voltage for power stage. Drain of the high-side N-channel MOSFET.			
30	BST	А	High-side driver supply pin. Connect a bootstrap capacitor between BST and pin 29.			

Type: A = Analog, I = Input, O = Output, I/O = Input/Output, PWR = Power, OD = Open-Drain

Functional Block Diagram



Typical Performance Characteristics

Unless otherwise noted: $V_{IN} = 24V$, $V_{OUT}=3.3V$, $I_{OUT}=8A$, f=400kHz, $T_A = 25^{\circ}C$. Schematic from the application information section.

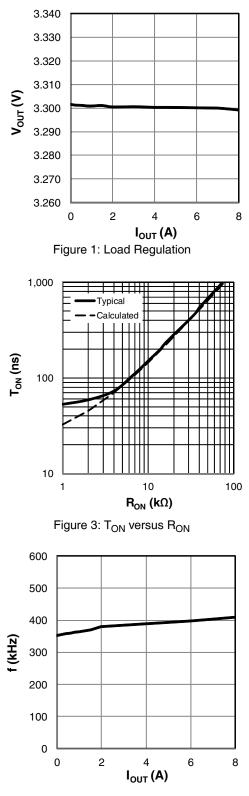


Figure 5: frequency versus I_{OUT}

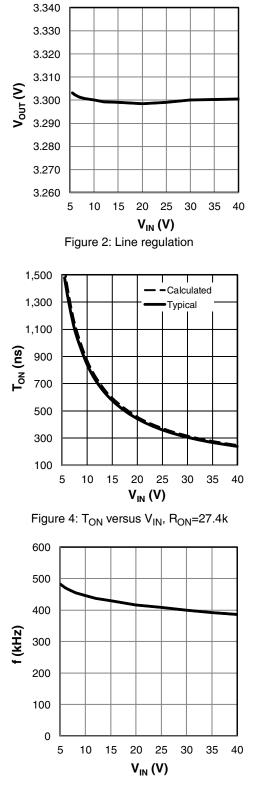
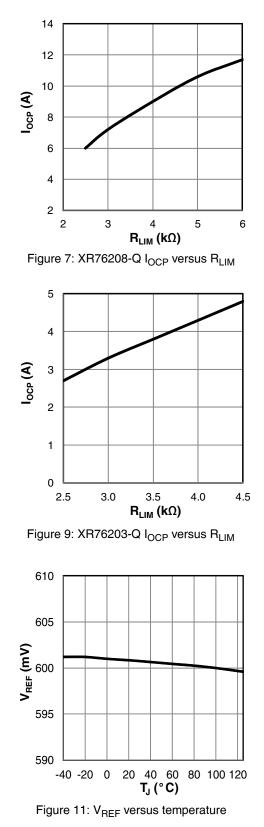
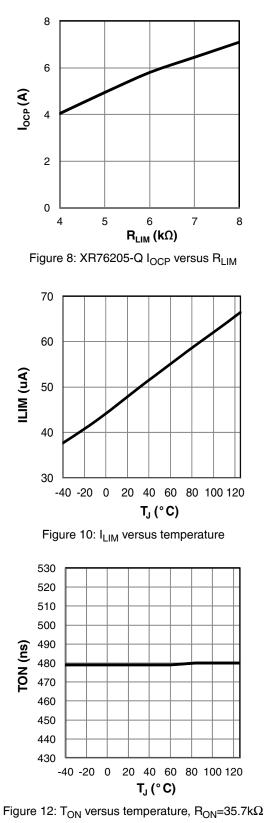


Figure 6: frequency versus VIN

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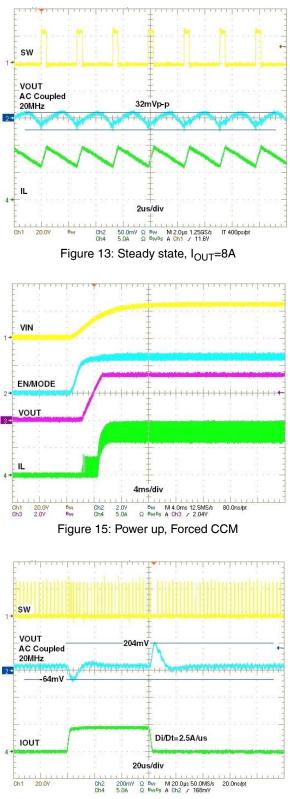
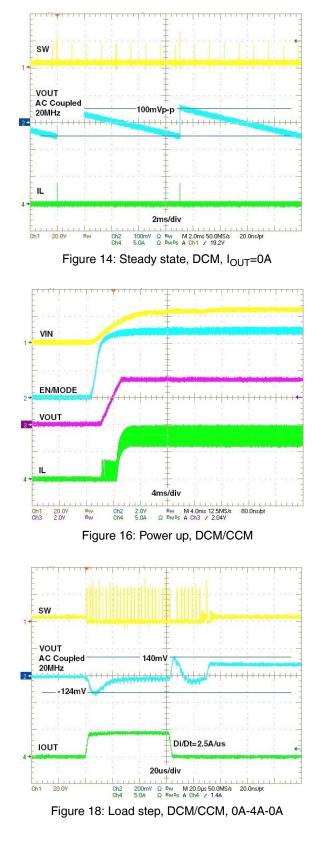


Figure 17: Load step, Forced CCM, 0A-4A-0A



Efficiency

Unless otherwise noted: $T_{AMBIENT} = 25^{\circ}C$, No Air flow, f=400kHz, Inductor losses are included, Schematic from the application information section.

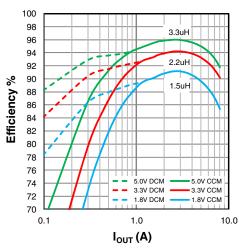


Figure 19: XR76208-Q efficiency, V_{IN}=12V

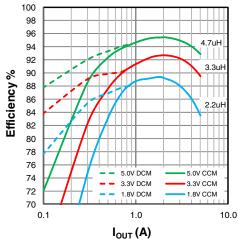


Figure 21: XR76205-Q efficiency, V_{IN}=12V

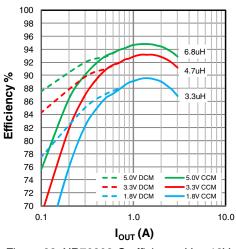


Figure 23: XR76203-Q efficiency, V_{IN}=12V

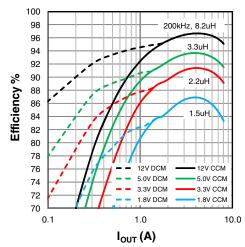


Figure 20: XR76208-Q efficiency, V_{IN}=24V

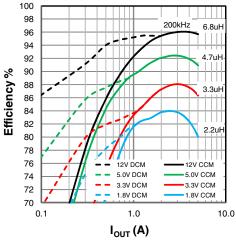


Figure 22: XR76205-Q efficiency, V_{IN}=24V

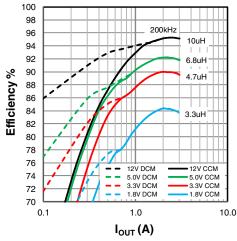
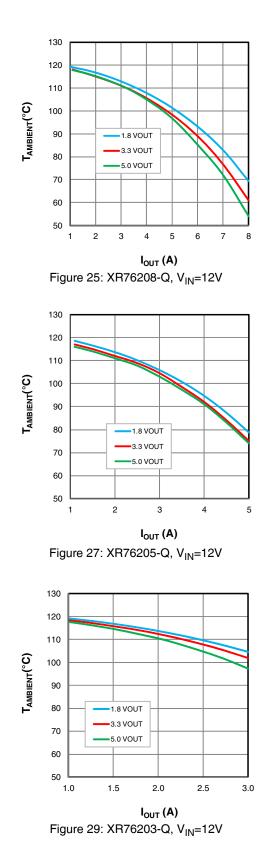


Figure 24: XR76203-Q efficiency, V_{IN}=24V

Thermal Derating

Unless otherwise noted: No Air flow, f=400kHz, Schematic from the application information section.



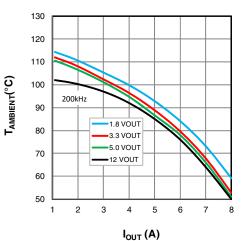


Figure 26: XR76208-Q, V_{IN}=24V

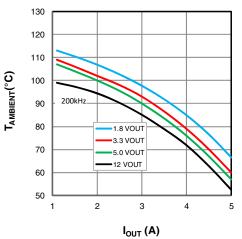


Figure 28: XR76205-Q, V_{IN}=24V

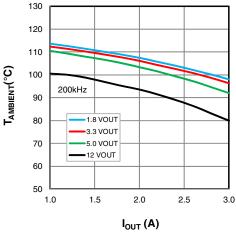


Figure 30: XR76203-Q, V_{IN}=24V

Functional Description

XR76203-Q, XR76205-Q and XR76208-Q are synchronous step-down proprietary emulated current-mode Constant On-Time (COT) regulators. The on-time, which is programmed via R_{ON} , is inversely proportional to V_{IN} and maintains a nearly constant frequency. The emulated current-mode control is stable with ceramic output capacitors.

Each switching cycle begins with GH signal turning on the high-side (control) FET for a preprogrammed time. At the end of the on-time, the high-side FET is turned off and the low-side (synchronous) FET is turned on for a preset minimum time (250ns nominal). This parameter is termed Minimum Off-Time. After the minimum off-time, the voltage at the feedback pin FB is compared to an internal voltage ramp at the feedback comparator. When V_{FB} drops below the ramp voltage, the high-side FET is turned on and the cycle repeats. This voltage ramp constitutes an emulated current ramp and makes possible the use of ceramic capacitors, in addition to other capacitor types, for output filtering.

Enable/Mode Input (EN/MODE)

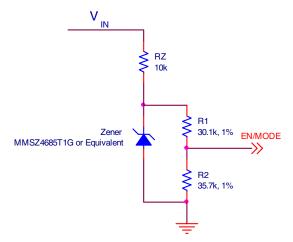
EN/MODE pin accepts a tri-level signal that is used to control turn on/off. It also selects between two modes of operation: 'Forced CCM' and 'DCM/CCM'. If EN is pulled below 1.8V, the Regulator shuts down. A voltage between 2.0V and 2.8V selects the Forced CCM mode which will run the Regulator in continuous conduction at all times. A voltage higher than 3.1V selects the DCM/CCM mode which will run the Regulator in discontinuous conduction at light loads.

Selecting the Forced CCM Mode

In order to set the Regulator to operate in Forced CCM, a voltage between 2.0V and 2.8V must be applied to EN/MODE. This can be achieved with an external control signal that meets the above voltage requirement. Where an external control is not available, the EN/MODE can be derived from V_{IN}. If V_{IN} is well regulated, use a resistor divider and set the voltage to 2.5V. If V_{IN} varies over a wide range, the circuit shown in figure 31 can be used to generate the required voltage. Note that at V_{IN} of 5.5V and 40V the nominal Zever voltage is 4.0V and 5.0V respectively. Therefore for V_{IN} in the range of 5.5V to 40V, the circuit shown in figure 31 will generate V_{EN} required for Forced CCM.

Selecting the DCM/CCM Mode

In order to set the Regulator operation to DCM/CCM, a voltage between 3.1V and 5.5V must be applied to EN/MODE pin. If an external control signal is available, it can be directly connected to EN/MODE. In applications where an external control is not available, EN/MODE input can be derived from V_{IN}. If V_{IN} is well regulated, use a resistor divider and set the voltage to 4V. If V_{IN} varies over a wide range, the circuit shown in figure 32 can be used to generate the required voltage.





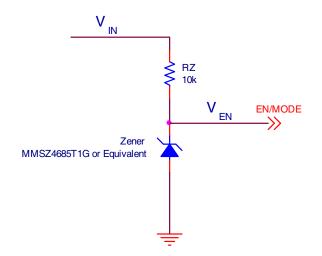


Figure 32: Selecting DCM/CCM by deriving EN/MODE from VIN

Programming the On-Time

The On-Time T_{ON} is programmed via resistor R_{ON} according to following equation:

$$\mathsf{R}_{\mathsf{ON}} = \frac{\mathsf{V}_{\mathsf{IN}} \times [\mathsf{T}_{\mathsf{ON}} - (25 \times 10^{-9})]}{3.05 \times 10^{-10}}$$

where T_{ON} is calculated from:

$$\mathsf{T}_{\mathsf{ON}} = \frac{\mathsf{V}_{\mathsf{OUT}}}{\mathsf{V}_{\mathsf{IN}} \times f \times Eff}$$

where:

f is the desired switching frequency at nominal I_{OUT}

Eff is the Regulator efficiency corresponding to nominal $I_{\mbox{OUT}}$ shown in figures 19-24

Substituting for T_{ON} in the first equation we get:

$$\mathsf{R}_{\mathsf{ON}} = \frac{\left(\frac{\mathsf{V}_{\mathsf{OUT}}}{f \times \textit{Eff}}\right) - \left[(25 \times 10^{-9}) \times \mathsf{V}_{\mathsf{IN}}\right]}{3.05 \times 10^{-10}}$$

Over-Current Protection (OCP)

If load current exceeds the programmed over-current, I_{OCP} for four consecutive switching cycles, the Module enters hiccup mode of operation. In hiccup, the MOSFET gates are turned off for 110ms (hiccup timeout). Following the hiccup timeout, a soft-start is attempted. If OCP persists, hiccup timeout will repeat. The Module will remain in hiccup mode until load current is reduced below the programmed I_{OCP} . In order to program the over-current protection, use the following equation:

$$RLIM = \frac{(I_{OCP} \times RDS) + 8mV}{ILIM}$$

Where:

RLIM is resistor value for programming I_{OCP}

I_{OCP} is the over-current threshold to be programmed

RDS is the MOSFET rated On Resistance; XR76208-Q=21.5m Ω , XR76205-Q=59m Ω , XR76203-Q=59m Ω

8mV is the OCP comparator maximum offset

ILIM is the internal current that generates the necessary OCP comparator threshold (use 45μ A).

Note that ILIM has a positive temperature coefficient of 0.4%/°C (figure 10). This is meant to roughly match and compensate for positive temperature coefficient of the synchronous FET. Graph of typical I_{OCP} versus RLIM is shown in figure 7-9. Maximum allowable RLIM for XR76205-Q is 8.06k Ω .

Short-Circuit Protection (SCP)

If the output voltage drops below 60% of its programmed value, the Module will enter hiccup mode. Hiccup will persist until short-circuit is removed. SCP circuit becomes active after PGOOD asserts high.

Over-Temperature (OTP)

OTP triggers at a nominal die temperature of 150°C. The gate of switching FET and synchronous FET are turned off. When die temperature cools down to 135°C, soft-start is initiated and operation resumes.

Programming the Output Voltage

Use an external voltage divider as shown in the Application Circuit to program the output voltage $V_{\mbox{OUT}}$

$$R1 = R2 \times \left(\frac{V_{OUT}}{0.6} - 1\right)$$

where R2 has a nominal value of $2k\Omega$.

Programming the Soft-start

Place a capacitor CSS between the SS and AGND pins to program the soft-start. In order to program a soft-start time of TSS, calculate the required capacitance CSS from the following equation:

$$CSS = TSS \times \left(\frac{10\mu A}{0.6V}\right)$$

Feed-Forward Capacitor (C_{FF})

A feed-forward capacitor (C_{FF}) may be necessary depending on the Equivalent Series Resistance (ESR) of C_{OUT}. If only ceramic output capacitors are used for C_{OUT} then a C_{FF} is necessary. Calculate C_{FF} from:

$$C_{FF} = \frac{1}{2 \times \pi \times R1 \times 7 \times f_{LC}}$$

where:

R1 is the resistor that C_{FF} is placed in parallel with

 f_{LC} is the frequency of output filter double-pole

 f_{LC} frequency must be less than 11kHz when using ceramic C_{OUT} . If necessary, increase L and/or C_{OUT} in order to meet this constraint.

When using capacitors with higher ESR, such as PANA-SONIC TPE series, a C_{FF} is not required provided following conditions are met:

1. The frequency of output filter LC double-pole f_{LC} should be less than 11kHz.

2. The frequency of ESR Zero $f_{Zero,ESR}$ should be at least five times larger than $f_{LC}.$

Note that if $f_{Zero,ESR}$ is less than $5xf_{LC}$, then it is recommended to set the f_{LC} at less than 2kHz. CFF is still not required.

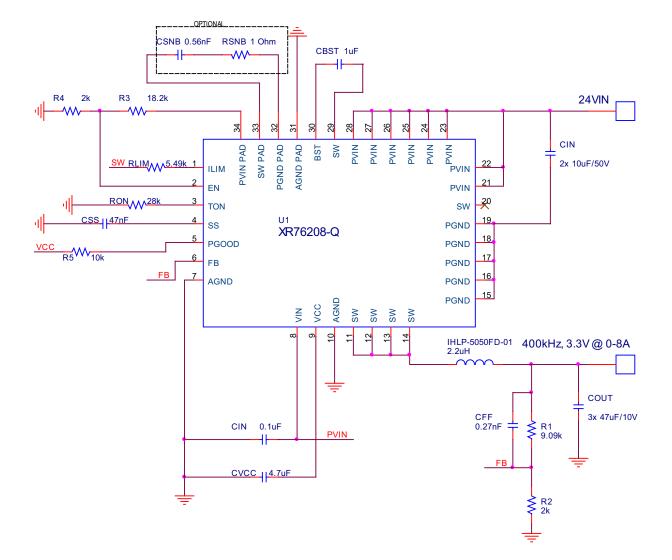
Maximum Allowable Voltage Ripple at FB pin

Note that the steady-state voltage ripple at feedback pin FB ($V_{FB,RIPPLE}$) must not exceed 50mV in order for the Regulator to function correctly. If $V_{FB,RIPPLE}$ is larger than 50mV then C_{OUT} should be increased as necessary in order to keep the $V_{FB,RIPPLE}$ below 50mV.

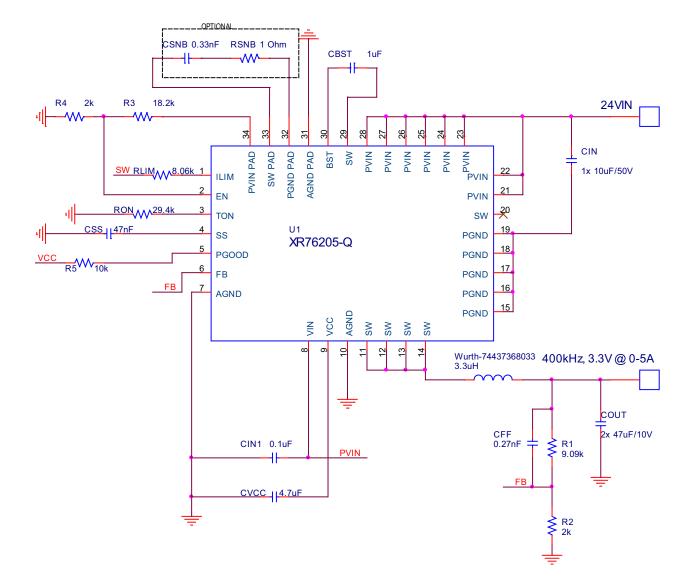
Feed-Forward Resistor (R_{FF})

Poor PCB layout can cause FET switching noise at the output and may couple to the FB pin via C_{FF} . Excessive noise at FB will cause poor load regulation. To solve this problem place a resistor R_{FF} in series with C_{FF} . R_{FF} value up to 2% of R1 is acceptable.

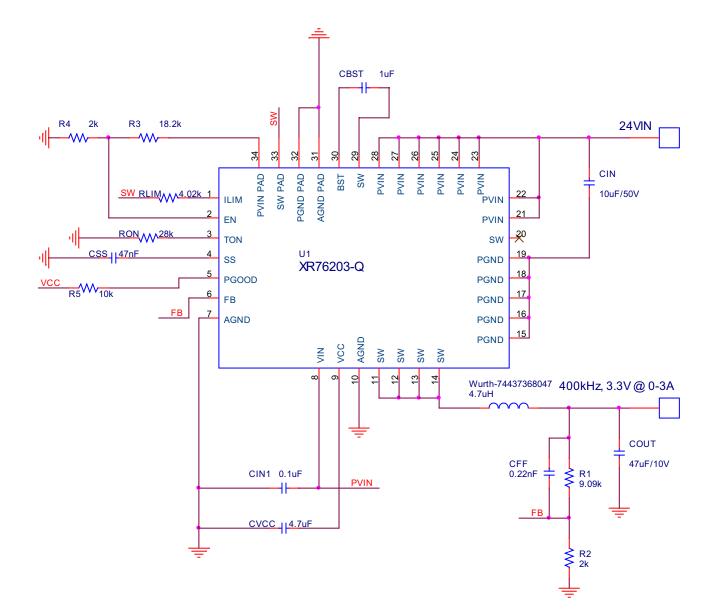
Application Circuit, XR76208-Q



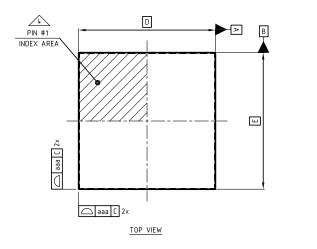
Application Circuit, XR76205-Q

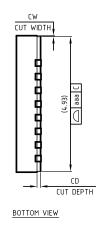


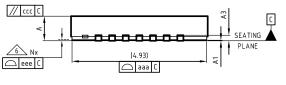
Application Circuit, XR76203-Q



Mechanical Dimensions

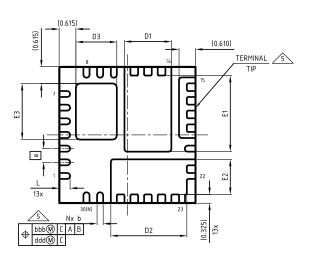








	Dimension Table					
Thickness Symbol A	V			NOTE		
I'mbol 3	MINIMUM	NOMINAL	MAXIMUM			
A	0.80	0.90	1.00			
A1	0.00	0.02	0.05			
A3		0.20 Ref.				
b	0.18	0.25	0.30	5		
CD	0.13	0.15	0.17			
CW	0.010	0.035	0.060			
D		5.00 BSC				
E		5.00 BSC				
e		0.50 BSC				
D1	1.570	1.720	1.820			
E1	2.635	2.785	2.885			
D2	2.635	2.785	2.885			
E2	1.135	1.285	1.385			
D3	1.345	1.495	1.595			
E3	1.903	2.053	2.153			
L	0.30	0.40	0.50			
aaa		0.05				
bbb	0.10					
CCC	0.10					
ddd	0.05					
eee	0.08					
N		30		3		
NOTES		1, 2				



TERMINAL DETAIL

NOTE : ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES AREA IN DEGREE

Drawing No.: POD-00000093 Revision: A

Ordering Information

Part Number	Operating Temperature Range	Lead-Free	Package	Packaging Method		
XR76208EL-Q	$-40^\circ C \le T_J \le 125^\circ C$	Yes	5x5mm QFN	Tray		
XR76208ELTR-Q		Tes		Tape and Reel		
XR76208EVB-Q		XR76208-Q Ev	Q Evaluation Board			
XR76205EL-Q	$-40^\circ C \le T_J \le 125^\circ C$	Yes	5x5mm QFN	Tray		
XR76205ELTR-Q		Tes		Tape and Reel		
XR76205EVB-Q		XR76205-Q Ev	valuation Board			
XR76203EL-Q	$-40^{\circ}C \leq T_{J} \leq 125^{\circ}C$	Yes	5x5mm QFN	Tray		
XR76203ELTR-Q		165		Tape and Reel		
XR76203EVB-Q		XR76203-Q Ev	3-Q Evaluation Board			

Notes:

1. Refer to www.exar.com/XR76203-Q, www.exar.com/XR76205-Q, www.exar.com/XR76208-Q for most up-to-date Ordering Information.

2. Visit www.exar.com for additional information on Environmental Rating.

Revision History

Revision	Date	Description		
1A	January 2017	Initial Release		
1B	March 2017	Removed preliminary from XR76203-Q		
1C	March 2017	Removed preliminary from XR76208-Q		

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